

#### 12-OUTPUT LOW POWER DIFFERENTIAL BUFFER FOR PCIE GEN3 AND QPI

9ZXL1230

### **General Description**

The 9ZXL1230 is a small-footprint, low power 12-output differential buffer that meets all the performance requirements of the Intel DB1900Z specification. It is pin compatible to the 9ZX21200. The 9ZXL1230 is backwards compatible to PCIe Gen2 and QPI 6.4GT/s specifications. A fixed, internal feedback path maintains low drift for critical QPI applications.

## **Recommended Application**

12-output Low Power PCle Gen3/QPI differential buffer for Romley

### **Output Features**

• 12 - 0.7V low-power HCSL-compatible output pairs

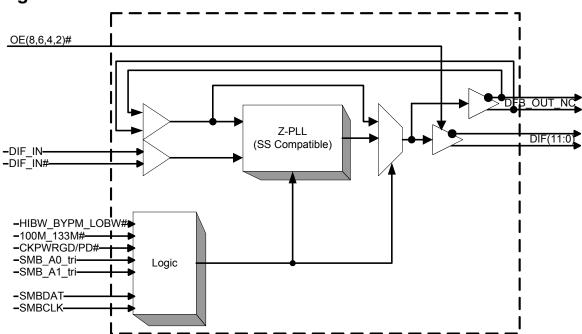
### Features/Benefits

- Low-power push-pull outputs; Save power and board space - no Rp
- Pin compatible to 9ZX21200; easy path to >50% power savings
- Space-saving 56-pin QFN package
- Fixed feedback path for 0ps input-to-output delay
- 9 Selectable SMBus Addresses; Mulitple devices can share the same SMBus Segment
- 4 OE# pins; Hardware control of four outputs, other outputs free run
- PLL or bypass mode; PLL can dejitter incoming clock
- 100MHz or 133MHz PLL mode operation; supports PCle and QPI applications
- Selectable PLL bandwidth; minimizes jitter peaking in downstream PLL's
- Spread Spectrum Compatible; tracks spreading input clock for low EMI

## **Key Specifications**

- Cycle-to-cycle jitter <50ps
- Output-to-output skew <65 ps
- Input-to-output delay variation <50ps
- PCIe Gen3 phase jitter <1.0ps RMS
- QPI 9.6GT/s 12UI phase jitter < 0.2ps RMS

## **Block Diagram**

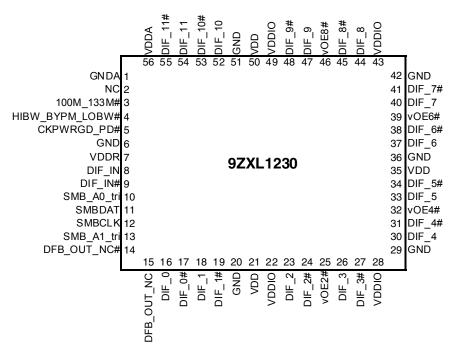


IDT® 12-OUTPUT LOW POWER DIFFERENTIAL BUFFER FOR PCIE GEN3 AND QPI

9ZXL1230

REV C 112015

## **Pin Configuration**



Note: Pins with ^ prefix have internal 120K pullup Pins with v prefix have internal 120K pulldowm

### **Power Management Table**

| CKPWRGD_PD# | DIF_IN/<br>DIF_IN# | SMBus<br>EN bit | DIF(11:0)/<br>DIF(11:0)# | PLL STATE<br>IF NOT IN<br>BYPASS<br>MODE |
|-------------|--------------------|-----------------|--------------------------|--|
| 0           | Х                  | X               | Low/Low                  | OFF                                      |
| 1           | Running            | 0               | Low/Low                  | ON                                       |
| l '         | running            | 1               | Runnina                  | ON                                       |

### Functionality at Power-up (PLL mode)

| 100M_133M# | DIF_IN<br>MHz | DIF(11:0) |  |  |
|------------|---------------|-----------|--|--|
| 1          | 100.00        | DIF_IN    |  |  |
| 0          | 133.33        | DIF_IN    |  |  |

#### **Power Connections**

| VDD      | VDDIO       | GND          | Description  |
|----------|-------------|--------------|--------------|
| 56       |             | 1            | Analog PLL   |
| 7        |             | 6            | Analog Input |
| 21,35,50 | 22,28,43,49 | 20,29,36,42, | DIF clocks   |

### **PLL Operating Mode Readback Table**

| HiBW_BypM_LoBW# | Byte0, bit 7 | Byte 0, bit 6 |
|-----------------|--------------|---------------|
| Low (Low BW)    | 0            | 0             |
| Mid (Bypass)    | 0            | 1             |
| High (High BW)  | 1            | 1             |

### **Tri-Level Input Thresholds**

| Level | Voltage                           |
|-------|-----------------------------------|
| Low   | <0.8V                             |
| Mid   | 1.2 <vin<1.8v< td=""></vin<1.8v<> |
| High  | Vin > 2.2V                        |

### **PLL Operating Mode**

| HiBW_BypM_LoBW# | MODE      |
|-----------------|-----------|
| Low             | PLL Lo BW |
| Mid             | Bypass    |
| High            | PLL Hi BW |

NOTE: PLL is OFF in Bypass Mode

### 9ZXL1230 SMBus Addressing

| Pi         | n          |               |
|------------|------------|---------------|
| SMB_A1_tri | SMB_A0_tri | SMBus Address |
| 0          | 0          | D8            |
| 0          | М          | DA            |
| 0          | 1          | DE            |
| M          | 0          | C2            |
| M          | М          | C4            |
| M          | 1          | C6            |
| 1          | 0          | CA            |
| 1          | М          | CC            |
| 1          | 1          | CE            |

# **Pin Descriptions**

| PIN # | PIN NAME            | TYPE | DESCRIPTION  |
|-------|---------------------|------|--|
| 1     | GNDA                | PWR  | Ground pin for the PLL core.   |
| 2     | NC                  | N/A  | No Connection.   |
| 3     | 100M_133M#          | IN   | 3.3V Input to select operating frequency   |
| 3     | 1 001VI_ 1331VI#    | IIN  | See Functionality Table for Definition   |
| 4     | HIBW_BYPM_LOBW#     | IN   | Trilevel input to select High BW, Bypass or Low BW mode.   |
| 4     | THOVV_DIT WI_LODVV# | IIN  | See PLL Operating Mode Table for Details.  |
| 5     | CKPWRGD_PD#         | IN   | Notifies device to sample latched inputs and start up on first high assertion, or exit Power Down Mode on                                      |
|       |                     |      | subsequent assertions. Low enters Power Down Mode.   |
| 6     | GND                 | PWR  | Ground pin.  |
| 7     | VDDR                | PWR  | 3.3V power for differential input clock (receiver). This VDD should be treated as an analog power rail and                                     |
|       |                     |      | filtered appropriately.  |
| 8     | DIF_IN              |      | 0.7 V Differential TRUE input  |
| 9     | DIF_IN#             | IN   | 0.7 V Differential Complementary Input   |
| 10    | SMB_A0_tri          | IN   | SMBus address bit. This is a tri-level input that works in conjunction with the SMB_A1 to decode 1 of 9  |
|       |                     |      | SMBus Addresses.   |
|       | SMBDAT              | I/O  | Data pin of SMBUS circuitry, 5V tolerant   |
| 12    | SMBCLK              | IN   | Clock pin of SMBUS circuitry, 5V tolerant  |
| 13    | SMB_A1_tri          | IN   | SMBus address bit. This is a tri-level input that works in conjunction with the SMB_A0 to decode 1 of 9  |
|       |                     |      | SMBus Addresses.   |
| 1 44  | DED OUT NO!         | OUT  | Complementary half of differential feedback output, provides feedback signal to the PLL for synchronization                                    |
| 14    | DFB_OUT_NC#         | OUT  | with input clock to eliminate phase error. This pin should NOT be connected on the circuit board, the feedback                                 |
|       |                     |      | is internal to the package.  True half of differential feedback output, provides feedback signal to the PLL for synchronization with the input |
| 15    | DED OUT NO          | OUT  | l · · · · · · · · · · · · · · · · · · ·  |
| 15    | DFB_OUT_NC          | OUT  | clock to eliminate phase error. This pin should NOT be connected on the circuit board, the feedback is internal                                |
| 16    | DIF_0               | OUT  | to the package.  0.7V differential true clock output   |
|       | DIF_0#              |      | 0.7V differential true clock output  |
|       | DIF_1               |      | 0.7V differential complementary clock output   |
|       | DIF_1#              |      | 0.7V differential true clock output  |
|       | GND                 |      | Ground pin.  |
| 21    | VDD                 |      | Power supply, nominal 3.3V   |
|       | VDDIO               |      | Power supply for differential outputs  |
|       | DIF_2               |      | 0.7V differential true clock output  |
|       | DIF_2#              |      | 0.7V differential Complementary clock output   |
|       |                     |      | Active low input for enabling DIF pair 2.  |
| 25    | OE2#                | IN   | 1 =disable outputs, 0 = enable outputs   |
| 26    | DIF_3               | OUT  | 0.7V differential true clock output  |
|       | DIF_3#              |      | 0.7V differential Complementary clock output   |
|       | VDDIO               |      | Power supply for differential outputs  |
|       | GND                 |      | Ground pin.  |
|       | DIF_4               |      | 0.7V differential true clock output  |
| 31    | DIF_4#              | OUT  | 0.7V differential Complementary clock output   |

# **Pin Descriptions (cont.)**

| 32 OE4# Active low input for enabling DIF pair 4            |  |
|---|--|
|   |  |
| 1 =disable outputs, 0 = enable outputs                      |  |
| 33 DIF_5 OUT 0.7V differential true clock output            |  |
| 34 DIF_5# OUT 0.7V differential Complementary clock output  |  |
| 35 VDD PWR Power supply, no minal 3.3V                      |  |
| 36 GND PWR Ground pin.                                      |  |
| 37 DIF_6 OUT 0.7V differential true clock output            |  |
| 38 DIF_6# OUT 0.7V differential Complementary clock output  |  |
| 39 OE6# Active low input for enabling DIF pair 6.           |  |
| 1 =disable outputs, 0 = enable outputs                      |  |
| 40 DIF_7 OUT 0.7V differential true clock output            |  |
| 41 DIF_7# OUT 0.7V differential Complementary clock output  |  |
| 42 GND PWR Ground pin.                                      |  |
| 43 VDDIO PWR Power supply for differential outputs          |  |
| 44 DIF_8 OUT 0.7V differential true clock output            |  |
| 45 DIF_8# OUT 0.7V differential Complementary clock output  |  |
| 46 OE8# Active low input for enabling DIF pair 8.           |  |
| 40 UEo# IIN 1 =disable outputs, 0 = enable outputs          |  |
| 47 DIF_9 OUT 0.7V differential true clock output            |  |
| 48 DIF_9# OUT 0.7V differential Complementary clock output  |  |
| 49 VDDIO PWR Power supply for differential outputs          |  |
| 50 VDD PWR Power supply, nominal 3.3V                       |  |
| 51 GND PWR Ground pin.                                      |  |
| 52 DIF_10 OUT 0.7V differential true clock output           |  |
| 53 DIF_10# OUT 0.7V differential Complementary clock output |  |
| 54 DIF_11 OUT 0.7V differential true clock output           |  |
| 55 DIF_11# OUT 0.7V differential Complementary clock output |  |
| 56 VDDA PWR 3.3V power for the PLL core.                    |  |

## **Absolute Maximum Ratings**

Stresses above the ratings listed below can cause permanent damage to the 9ZXL1230. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

| PARAMETER                | SYMBOL      | CONDITIONS                 | MIN     | TYP | MAX           | UNITS | NOTES |
|--------------------------|-------------|----------------------------|---------|-----|---------------|-------|-------|
| 3.3V Core Supply Voltage | VDD, VDDA   | VDD for core logic and PLL |         |     | 4.6           | V     | 1,2   |
| IO Supply Voltage        | VDD_IO      | VDD for differential IO    |         |     | 4.6           | V     | 1,2   |
| Input Low Voltage        | $V_{IL}$    |                            | GND-0.5 |     |               | V     | 1     |
| Input High Voltage       | $V_{IH}$    | Except for SMBus interface |         |     | $V_{DD}+0.5V$ | V     | 1     |
| Input High Voltage       | $V_{IHSMB}$ | SMBus clock and data pins  |         |     | 5.5V          | V     | 1     |
| Storage Temperature      | Ts          |                            | -65     |     | 150           | °C    | 1     |
| Junction Temperature     | Tj          |                            |         |     | 125           | °C    | 1     |
| Input ESD protection     | ESD prot    | Human Body Model           | 2000    |     |               | V     | 1     |

<sup>&</sup>lt;sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

## **Electrical Characteristics-DIF\_IN Clock Input Parameters**

 $T_A = T_{COM}$ ; Supply Voltage  $V_{DD} = 3.3 \text{ V +/-5\%}$ , VDD\_IO = 1.05 to 3.3V +/-5%

| 7 OON 11 7 O                        | 00                 |  |     |     |     |       |       |
|-------------------------------------|--------------------|--|-----|-----|-----|-------|-------|
| PARAMETER                           | SYMBOL             | CONDITIONS                             | MIN | TYP | MAX | UNITS | NOTES |
| Input Crossover Voltage -<br>DIF_IN | V <sub>CROSS</sub> | Cross Over Voltage                     | 150 |     | 900 | mV    | 1     |
| Input Swing - DIF_IN                | V <sub>SWING</sub> | Differential value                     | 300 |     |     | mV    | 1     |
| Input Slew Rate - DIF_IN            | dv/dt              | Measured differentially                | 0.4 |     | 8   | V/ns  | 1,2   |
| Input Leakage Current               | I <sub>IN</sub>    | $V_{IN} = V_{DD}$ , $V_{IN} = GND$     | -5  |     | 5   | uA    |       |
| Input Duty Cycle                    | d <sub>tin</sub>   | Measurement from differential wavefrom | 45  |     | 55  | %     | 1     |
| Input Jitter - Cycle to Cycle       | $J_{DIFIn}$        | Differential Measurement               | 0   |     | 125 | ps    | 1     |

<sup>&</sup>lt;sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>&</sup>lt;sup>2</sup> Operation under these conditions is neither implied nor guaranteed.

<sup>&</sup>lt;sup>2</sup>Slew rate measured through +/-75mV window centered around differential zero

# **Electrical Characteristics-Input/Supply/Common Output Parameters**

 $T_A = T_{COM}$ ; Supply Voltage  $V_{DD} = 3.3 \ V + /-5\%$ , VDD\_IO = 1.05 to 3.3V + /-5%

| PARAMETER                        | SYMBOL                | CONDITIONS   | MIN       | TYP    | MAX                   | UNITS    | NOTES |
|----------------------------------|-----------------------|--|-----------|--------|-----------------------|----------|-------|
| Ambient Operating Temperature    | T <sub>COM</sub>      | Commmercial range  | 0         |        | 70                    | °C       | 1     |
| Input High Voltage               | V <sub>IH</sub>       | Single-ended inputs, except SMBus, low threshold and tri-level inputs  | 2         |        | V <sub>DD</sub> + 0.3 | V        | 1     |
| Input Low Voltage                | $V_{IL}$              | Single-ended inputs, except SMBus, low threshold and tri-level inputs  | GND - 0.3 |        | 0.8                   | <b>V</b> | 1     |
|                                  | I <sub>IN</sub>       | Single-ended inputs, $V_{IN} = GND$ , $V_{IN} = VDD$   | -5        |        | 5                     | uA       | 1     |
| Input Current                    | I <sub>INP</sub>      | $Single-ended inputs \\ V_{IN} = 0 \text{ V}; \text{ Inputs with internal pull-up resistors} \\ V_{IN} = \text{VDD}; \text{ Inputs with internal pull-down resistors}$ | -200      |        | 200                   | uA       | 1     |
|                                  | $F_{ibyp}$            | V <sub>DD</sub> = 3.3 V, Bypass mode   | 33        |        | 150                   | MHz      | 2     |
| Input Frequency                  | $F_{ipll}$            | $V_{DD} = 3.3 \text{ V}, 100\text{MHz PLL mode}$   | 90        | 100.00 | 110                   | MHz      | 2     |
|                                  | F <sub>ipll</sub>     | $V_{DD} = 3.3 \text{ V}, 133.33 \text{MHz PLL mode}$   | 120       | 133.33 | 147                   | MHz      | 2     |
| Pin Inductance                   | $L_{pin}$             |  |           |        | 7                     | nΗ       | 1     |
|                                  | C <sub>IN</sub>       | Logic Inputs, except DIF_IN  | 1.5       |        | 5                     | pF       | 1     |
| Capacitance                      | C <sub>INDIF_IN</sub> | DIF_IN differential clock inputs   | 1.5       |        | 2.7                   | pF       | 1,4   |
| ·                                | C <sub>OUT</sub>      | Output pin capacitance   |           |        | 6                     | pF       | 1     |
| Clk Stabilization                | T <sub>STAB</sub>     | From V <sub>DD</sub> Power-Up and after input clock stabilization or de-assertion of PD# to 1st clock  |           |        | 1                     | ms       | 1,2   |
| Input SS Modulation<br>Frequency | f <sub>MODIN</sub>    | Allowable Frequency<br>(Triangular Modulation)   | 30        |        | 33                    | kHz      | 1     |
| OE# Latency                      | t <sub>LATOE#</sub>   | DIF start after OE# assertion DIF stop after OE# deassertion   | 4         |        | 12                    | cycles   | 1,3   |
| Tdrive_PD#                       | t <sub>DRVPD</sub>    | DIF output enable after<br>PD# de-assertion  |           |        | 300                   | us       | 1,3   |
| Tfall                            | $t_{F}$               | Fall time of control inputs  |           |        | 10                    | ns       | 1,2   |
| Trise                            | $t_R$                 | Rise time of control inputs  |           |        | 10                    | ns       | 1,2   |
| SMBus Input Low Voltage          | $V_{ILSMB}$           |  |           |        | 0.8                   | V        | 1     |
| SMBus Input High Voltage         | $V_{IHSMB}$           |  | 2.1       |        | $V_{\rm DDSMB}$       | V        | 1     |
| SMBus Output Low Voltage         | $V_{OLSMB}$           | @ I <sub>PULLUP</sub>  |           |        | 0.4                   | V        | 1     |
| SMBus Sink Current               | I <sub>PULLUP</sub>   | @ V <sub>OL</sub>  | 4         |        |                       | mA       | 1     |
| Nominal Bus Voltage              | $V_{\text{DDSMB}}$    | 3V to 5V +/- 10%   | 2.7       |        | 5.5                   | ٧        | 1     |
| SCLK/SDATA Rise Time             | t <sub>RSMB</sub>     | (Max VIL - 0.15) to (Min VIH + 0.15)   |           |        | 1000                  | ns       | 1     |
| SCLK/SDATA Fall Time             | t <sub>FSMB</sub>     | (Min VIH + 0.15) to (Max VIL - 0.15)   |           |        | 300                   | ns       | 1     |
| SMBus Operating<br>Frequency     | f <sub>MAXSMB</sub>   | Maximum SMBus operating frequency  |           |        | 100                   | kHz      | 1,5   |

<sup>&</sup>lt;sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>&</sup>lt;sup>2</sup>Control input must be monotonic from 20% to 80% of input swing.

 $<sup>^3</sup>$ Time from deassertion until outputs are >200 mV

<sup>&</sup>lt;sup>4</sup>DIF\_IN input

<sup>&</sup>lt;sup>5</sup>The differential input clock must be running for the SMBus to be active

### Electrical Characteristics-DIF 0.7V Low Power Differential Outputs

 $T_A = T_{COM}$ ; Supply Voltage  $V_{DD} = 3.3 \text{ V +/-5\%}$ , VDD\_IO = 1.05 to 3.3V +/-5%

| PARAMETER              | SYMBOL     | CONDITIONS  | MIN  | TYP  | MAX  | UNITS | NOTES   |
|------------------------|------------|---|------|------|------|-------|---------|
| Slew rate              | Trf        | Scope averaging on  | 1    | 3.3  | 4    | V/ns  | 1, 2, 3 |
| Slew rate matching     | ΔTrf       | Slew rate matching, Scope averaging on  |      | 7    | 20   | %     | 1, 2, 4 |
| Voltage High           | VHigh      | Statistical measurement on single-ended signal using oscilloscope math function. (Scope averaging on) |      | 778  | 850  | mV    | 1       |
| Voltage Low            | VLow       |   |      | 0    | 150  | ""    | 1       |
| Max Voltage            | Vmax       | Measurement on single ended signal using  |      | 985  | 1150 | mV    | 1       |
| Min Voltage            | Vmin       | absolute value. (Scope averaging off)   | -300 | -91  |      | IIIV  | 1       |
| Vswing                 | Vswing     | Scope averaging off   | 300  | 1556 |      | mV    | 1, 2    |
| Crossing Voltage (abs) | Vcross_abs | Scope averaging off   | 300  | 458  | 550  | mV    | 1, 5    |
| Crossing Voltage (var) | Δ-Vcross   | Scope averaging off   |      | 17   | 140  | mV    | 1, 6    |

<sup>&</sup>lt;sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.  $C_L = 2pF$  with  $R_S = 33Ω$  for Zo = 50Ω (100Ω differential trace impedance).

## **Electrical Characteristics-Current Consumption**

 $T_A = T_{COM}$ ; Supply Voltage  $V_{DD} = 3.3 \text{ V } +/-5\%$ , VDD\_IO = 1.05 to 3.3V +/-5%

| PARAMETER         | SYMBOL                 | CONDITIONS   | MIN | TYP  | MAX | UNITS | NOTES |
|-------------------|------------------------|--|-----|------|-----|-------|-------|
|                   | I <sub>DDVDD</sub>     | 133MHz, $C_L$ = Full load; VDD rail                |     | 18   | 25  | mA    | 1     |
| Operating Current | I <sub>DDVDDA</sub>    | 133MHz, C <sub>L</sub> = Full load; VDDA+VDDR rail |     | 16   | 20  | mA    | 1     |
|                   | I <sub>DDVDDIO</sub>   | 133MHz, C <sub>L</sub> = Full load; VDD IO rail    |     | 101  | 106 | mA    | 1     |
|                   | I <sub>DDVDDPD</sub>   | Power Down, VDD Rail                               |     | 0.01 | 1   | mA    | 1     |
| Powerdown Current | I <sub>DDVDDAPD</sub>  | Power Down, VDDA+VDDR Rail                         |     | 3    | 5   | mA    | 1     |
|                   | I <sub>DDVDDIOPD</sub> | Power Down, VDD_IO Rail                            |     | 0.01 | 0.2 | mA    | 1     |

<sup>&</sup>lt;sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>&</sup>lt;sup>2</sup> Measured from differential waveform

<sup>&</sup>lt;sup>3</sup> Slew rate is measured through the Vswing voltage range centered around differential 0V. This results in a +/-150mV window around differential 0V.

<sup>&</sup>lt;sup>4</sup> Matching applies to rising edge rate for Clock and falling edge rate for Clock#. It is measured using a +/-75mV window centered on the average cross point where Clock rising meets Clock# falling. The median cross point is used to calculate the voltage thresholds the oscilloscope is to use for the edge rate calculations.

<sup>&</sup>lt;sup>5</sup> Vcross is defined as voltage where Clock = Clock# measured on a component test board and only applies to the differential rising edge (i.e. Clock rising and Clock# falling).

<sup>&</sup>lt;sup>6</sup> The total variation of all Vcross measurements in any particular system. Note that this is a subset of Vcross\_min/max (Vcross absolute) allowed. The intent is to limit Vcross induced modulation by setting Δ-Vcross to be smaller than Vcross absolute.

### **Electrical Characteristics-Skew and Differential Jitter Parameters**

 $T_A = T_{COM}$ ; Supply Voltage  $V_{DD} = 3.3 \text{ V +/-5\%}$ , VDD\_IO = 1.05 to 3.3V +/-5%

| PARAMETER              | SYMBOL                | CONDITIONS  | MIN  | TYP  | MAX | UNITS       | NOTES     |
|------------------------|-----------------------|---|------|------|-----|-------------|-----------|
| CLK_IN, DIF[x:0]       | t <sub>SPO_PLL</sub>  | Input-to-Output Skew in PLL mode nominal value @ 25°C, 3.3V                             | -100 | -60  | 100 | ps          | 1,2,4,5,8 |
| CLK_IN, DIF[x:0]       | t <sub>PD_BYP</sub>   | Input-to-Output Skew in Bypass mode nominal value @ 25°C, 3.3V                          | 2.5  | 3.2  | 4.5 | ns          | 1,2,3,5,8 |
| CLK_IN, DIF[x:0]       | t <sub>DSPO_PLL</sub> | Input-to-Output Skew Varation in PLL mode across voltage and temperature                | -50  | 0    | 50  | ps          | 1,2,3,5,8 |
| CLK_IN, DIF[x:0]       | t <sub>DSPO_BYP</sub> | Input-to-Output Skew Varation in Bypass mode across voltage and temperature             | -250 |      | 250 | ps          | 1,2,3,5,8 |
| CLK_IN, DIF[x:0]       | t <sub>DTE</sub>      | Random Differential Tracking error beween two<br>9ZX devices in Hi BW Mode              |      | 3    | 5   | ps<br>(rms) | 1,2,3,5,8 |
| CLK_IN, DIF[x:0]       | t <sub>DSSTE</sub>    | Random Differential Spread Spectrum Tracking error beween two 9ZX devices in Hi BW Mode |      | 10   | 75  | ps          | 1,2,3,5,8 |
| DIF{x:0]               | t <sub>SKEW_ALL</sub> | Output-to-Output Skew across all outputs (Common to Bypass and PLL mode)                |      | 60   | 65  | ps          | 1,2,3,8   |
| PLL Jitter Peaking     | jpeak-hibw            | LOBW#_BYPASS_HIBW = 1   | 0    | 1.2  | 2.5 | dB          | 7,8       |
| PLL Jitter Peaking     | jpeak-lobw            | LOBW#_BYPASS_HIBW = 0   | 0    | 0.76 | 2   | dB          | 7,8       |
| PLL Bandwidth          | pll <sub>HIBW</sub>   | LOBW#_BYPASS_HIBW = 1   | 2    | 3    | 4   | MHz         | 8,9       |
| PLL Bandwidth          | pll <sub>LOBW</sub>   | LOBW#_BYPASS_HIBW = 0   | 0.7  | 1.1  | 1.4 | MHz         | 8,9       |
| Duty Cycle             | t <sub>DC</sub>       | Measured differentially, PLL Mode   | 45   | 50.1 | 55  | %           | 1         |
| Duty Cycle Distortion  | t <sub>DCD</sub>      | Measured differentially, Bypass Mode<br>@100MHz   | -2   | 0    | 2   | %           | 1,10      |
| Jitter, Cycle to cycle | t:                    | PLL mode  |      | 34   | 50  | ps          | 1,11      |
| onto, Oyolo to cyclo   | t <sub>jcyc-cyc</sub> | Additive Jitter in Bypass Mode  |      | 17   | 50  | ps          | 1,11      |

#### Notes for preceding table:

<sup>1</sup> Measured into fixed 2 pF load cap. Input to output skew is measured at the first output edge following the corresponding input.

<sup>&</sup>lt;sup>2</sup> Measured from differential cross-point to differential cross-point. This parameter can be tuned with external feedback path, if present.

<sup>&</sup>lt;sup>3</sup> All Bypass Mode Input-to-Output specs refer to the timing between an input edge and the specific output edge created by it.

<sup>&</sup>lt;sup>4</sup> This parameter is deterministic for a given device

<sup>&</sup>lt;sup>5</sup> Measured with scope averaging on to find mean value.

<sup>&</sup>lt;sup>6</sup>.t is the period of the input clock

<sup>&</sup>lt;sup>7</sup> Measured as maximum pass band gain. At frequencies within the loop BW, highest point of magnification is called PLL jitter peaking.

<sup>&</sup>lt;sup>8.</sup> Guaranteed by design and characterization, not 100% tested in production.

Measured at 3 db down or half power point.

<sup>&</sup>lt;sup>10</sup> Duty cycle distortion is the difference in duty cycle between the output and the input clock when the device is operated in bypass mode.

<sup>&</sup>lt;sup>11</sup> Measured from differential waveform

### **Electrical Characteristics-Phase Jitter Parameters**

 $T_A = T_{COM}$ ; Supply Voltage  $V_{DD} = 3.3 \text{ V +/-5\%}$ , VDD\_IO = 1.05 to 3.3V +/-5%

| PARAMETER                 | SYMBOL                   | CONDITIONS   | MIN | TYP  | MAX | UNITS       | Notes   |
|---------------------------|--------------------------|--|-----|------|-----|-------------|---------|
|                           | t <sub>iphPCleG1</sub>   | PCIe Gen 1   |     | 34   | 86  | ps (p-p)    | 1,2,3   |
|                           | t <sub>iphPCle</sub> G2  | PCIe Gen 2 Lo Band<br>10kHz < f < 1.5MHz               |     | 1.2  | 3   | ps<br>(rms) | 1,2     |
|                           | <sup>t</sup> jphPCleG2   | PCIe Gen 2 High Band<br>1.5MHz < f < Nyquist (50MHz)   |     | 2.2  | 3.1 | ps<br>(rms) | 1,2     |
| <sup>4</sup> DIF_IN input | t <sub>jphPCleG3</sub>   | PCIe Gen 3<br>(PLL BW of 2-4MHz, CDR = 10MHz)          |     | 0.5  | 1   | ps<br>(rms) | 1,2,4   |
|                           |                          | QPI & SMI<br>(100MHz or 133MHz, 4.8Gb/s, 6.4Gb/s 12UI) |     | 0.24 | 0.5 | ps<br>(rms) | 1,5     |
|                           | t <sub>jphQPI_</sub> SMI | QPI & SMI<br>(100MHz, 8.0Gb/s, 12UI)                   |     | 0.14 | 0.3 | ps<br>(rms) | 1,5     |
|                           |                          | QPI & SMI<br>(100MHz, 9.6Gb/s, 12UI)                   |     | 0.12 | 0.2 | ps<br>(rms) | 1,5     |
|                           | t <sub>jphPCleG1</sub>   | PCle Gen 1   |     | 3.7  | 10  | ps (p-p)    | 1,2,3   |
|                           |                          | PCIe Gen 2 Lo Band<br>10kHz < f < 1.5MHz               |     | 0.1  | 0.1 | ps<br>(rms) | 1,2,6   |
|                           | t <sub>jphPCleG2</sub>   | PCIe Gen 2 High Band<br>1.5MHz < f < Nyquist (50MHz)   |     | 0.4  | 0.5 | ps<br>(rms) | 1,2,6   |
|                           | t <sub>jphPCleG3</sub>   | PCIe Gen 3<br>(PLL BW of 2-4MHz, CDR = 10MHz)          |     | 0.09 | 0.2 | ps<br>(rms) | 1,2,4,6 |
|                           | t <sub>jphQPI_SMI</sub>  | QPI & SMI<br>(100MHz or 133MHz, 4.8Gb/s, 6.4Gb/s 12UI) |     | 0.14 | 0.1 | ps<br>(rms) | 1,5,6   |
|                           |                          | QPI & SMI<br>(100MHz, 8.0Gb/s, 12UI)                   |     | 0.01 | 0.1 | ps<br>(rms) | 1,5,6   |
|                           |                          | QPI & SMI<br>(100MHz, 9.6Gb/s, 12UI)                   |     | 0.01 | 0.1 | ps<br>(rms) | 1,5,6   |

<sup>&</sup>lt;sup>1</sup> Applies to all outputs.

<sup>&</sup>lt;sup>2</sup> See http://www.pcisig.com for complete specs

<sup>&</sup>lt;sup>3</sup> Sample size of at least 100K cycles. This figures extrapolates to 108ps pk-pk @ 1M cycles for a BER of 1-12.

<sup>&</sup>lt;sup>4</sup> Subject to final radification by PCI SIG.

<sup>&</sup>lt;sup>5</sup> Calculated from Intel-supplied Clock Jitter Tool v 1.6.3

<sup>&</sup>lt;sup>6</sup> For RMS figures, additive jitter is calculated by solving the following equation: (Additive jitter)<sup>2</sup> = (total jitter)<sup>2</sup> - (input jitter)<sup>2</sup>

## Clock Periods-Differential Outputs with Spread Spectrum Disabled

|         |              |             | Measurement Window |            |                            |            |            |             |       |       |
|---------|--------------|-------------|--------------------|------------|----------------------------|------------|------------|-------------|-------|-------|
|         | Center       | 1 Clock     | 1us                | 0.1s       | 0.1s                       | 0.1s       | 1us        | 1 Clock     |       |       |
| SSC OFF | Freq.<br>MHz | -c2c jitter | -SSC<br>Sh         | - ppm<br>L | 0 ppm<br>Period<br>Nominal | + ppm<br>L | +SSC<br>Sh | +c2c jitter | Units | Notes |
| DIF     | 100.00       | 9.94900     |                    | 9.99900    | 10.00000                   | 10.00100   |            | 10.05100    | ns    | 1,2,3 |
| Dii     | 133.33       | 7.44925     |                    | 7.49925    | 7.50000                    | 7.50075    |            | 7.55075     | ns    | 1,2,4 |

## Clock Periods-Differential Outputs with Spread Spectrum Enabled

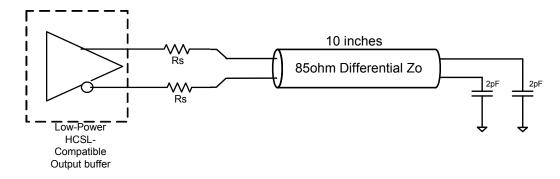
|        |              |                              |                                      |                                      | Measurement                | Window                               |                                      |                              |       |       |
|--------|--------------|------------------------------|--------------------------------------|--------------------------------------|----------------------------|--------------------------------------|--------------------------------------|------------------------------|-------|-------|
|        | Center       | 1 Clock                      | 1us                                  | 0.1s                                 | 0.1s                       | 0.1s                                 | 1us                                  | 1 Clock                      |       |       |
| SSC ON | Freq.<br>MHz | -c2c jitter<br>AbsPer<br>Min | -SSC<br>Short-Term<br>Average<br>Min | - ppm<br>Long-Term<br>Average<br>Min | 0 ppm<br>Period<br>Nominal | + ppm<br>Long-Term<br>Average<br>Max | +SSC<br>Short-Term<br>Average<br>Max | +c2c jitter<br>AbsPer<br>Max | Units | Notes |
| DIF    | 99.75        | 9.94906                      | 9.99906                              | 10.02406                             | 10.02506                   | 10.02607                             | 10.05107                             | 10.10107                     | ns    | 1,2,3 |
| Dii    | 133.00       | 7.44930                      | 7.49930                              | 7.51805                              | 7.51880                    | 7.51955                              | 7.53830                              | 7.58830                      | ns    | 1,2,4 |

#### Notes:

### **Differential Output Terminations**

| DIF Zo (Ω) | Rs (Ω) |
|------------|--------|
| 100        | 33     |
| 85         | 27     |

### 9ZXL Differential Test Loads



<sup>&</sup>lt;sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>&</sup>lt;sup>2</sup> All Long Term Accuracy specifications are guaranteed with the assumption that the input clock complies with CK420BQ/CK410B+ accuracy requirements (+/-100ppm). The 9ZXL1230 itself does not contribute to ppm error.

<sup>&</sup>lt;sup>3</sup> Driven by SRC output of main clock, 100 MHz PLL Mode or Bypass mode

 $<sup>^{</sup>m 4}$  Driven by CPU output of main clock, 133 MHz PLL Mode or Bypass mode

### **General SMBus Serial Interface Information for 9ZXL1230**

#### **How to Write**

- · Controller (host) sends a start bit
- · Controller (host) sends the write address
- IDT clock will acknowledge
- Controller (host) sends the beginning byte location = N
- IDT clock will acknowledge
- Controller (host) sends the byte count = X
- · IDT clock will acknowledge
- Controller (host) starts sending Byte N through Byte N+X-1
- IDT clock will acknowledge each byte one at a time
- · Controller (host) sends a Stop bit

|           | Index Blo  | ock '  | Write Operation      |
|-----------|------------|--------|----------------------|
| Controll  | er (Host)  |        | IDT (Slave/Receiver) |
| Т         | starT bit  |        |                      |
| Slave A   | Address    |        |                      |
| WR        | WRite      |        |                      |
|           |            |        | ACK                  |
| Beginning | g Byte = N |        |                      |
|           |            |        | ACK                  |
| Data Byte | Count = X  |        |                      |
|           |            |        | ACK                  |
| Beginnin  | g Byte N   |        |                      |
|           |            |        | ACK                  |
| 0         |            | ×      |                      |
| 0         |            | X Byte | 0                    |
| 0         |            | æ      | 0                    |
|           |            |        | 0                    |
| Byte N    | + X - 1    |        |                      |
|           |            |        | ACK                  |
| Р         | stoP bit   |        |                      |

#### **How to Read**

- · Controller (host) will send a start bit
- Controller (host) sends the write address
- IDT clock will acknowledge
- Controller (host) sends the beginning byte location = N
- IDT clock will acknowledge
- · Controller (host) will send a separate start bit
- · Controller (host) sends the read address
- IDT clock will acknowledge
- IDT clock will send the data byte count = X
- IDT clock sends Byte N+X-1
- IDT clock sends Byte 0 through Byte X (if X<sub>(H)</sub> was written to Byte 8)
- · Controller (host) will need to acknowledge each byte
- · Controller (host) will send a not acknowledge bit
- · Controller (host) will send a stop bit

|      | Index Block F   | Read O   | peration             |
|------|-----------------|----------|----------------------|
| Cor  | troller (Host)  |          | IDT (Slave/Receiver) |
| Т    | starT bit       |          |                      |
| SI   | ave Address     |          |                      |
| WR   | WRite           |          |                      |
|      |                 |          | ACK                  |
| Begi | nning Byte = N  |          |                      |
|      |                 |          | ACK                  |
| RT   | Repeat starT    |          |                      |
| SI   | ave Address     |          |                      |
| RD   | ReaD            |          |                      |
|      |                 |          | ACK                  |
|      |                 |          |                      |
|      |                 |          | Data Byte Count=X    |
|      | ACK             |          |                      |
|      |                 |          | Beginning Byte N     |
|      | ACK             |          |                      |
|      |                 | <u>e</u> | 0                    |
|      | 0               | X Byte   | 0                    |
|      | 0               | ×        | 0                    |
|      | 0               |          |                      |
|      |                 |          | Byte N + X - 1       |
| N    | Not acknowledge |          |                      |
| Р    | stoP bit        |          |                      |

SMBusTable: PLL Mode, and Frequency Select Register

| Byte  | 0 Pin# | Name       | Control Function             | Type | 0                      | 1             | Default |  |
|-------|--------|------------|------------------------------|------|------------------------|---------------|---------|--|
| Bit 7 | 3      | PLL Mode 1 | PLL Operating Mode Rd back 1 | R    | See PLL Op             | erating Mode  | Latch   |  |
| Bit 6 | 3      | PLL Mode 0 | PLL Operating Mode Rd back 0 | R    | Readba                 | Latch         |         |  |
| Bit 5 |        |            | Reserved                     |      |                        | 0             |         |  |
| Bit 4 |        |            | Reserved                     |      |                        |               |         |  |
| Bit 3 |        | PLL_SW_EN  | Enable S/W control of PLL BW | RW   | HW Latch               | SMBus Control | 0       |  |
| Bit 2 |        | PLL Mode 1 | PLL Operating Mode 1         | RW   | See PLL Operating Mode |               | 1       |  |
| Bit 1 |        | PLL Mode 0 | PLL Operating Mode 1         | RW   | Readback Table         |               | 1       |  |
| Bit 0 | 4      | 100M_133M# | Frequency Select Readback    | R    | 133MHz                 | 100MHz        | Latch   |  |

**Note:** Setting bit 3 to '1' allows the user to overide the Latch value from pin 5 via use of bits 2 and 1. Use the values from the PLL Operating Mode Readback Table. Note that Bits 7 and 6 will keep the value originally latched on pin 5. A warm reset of the system will have to accomplished if the user changes these bits.

SMBusTable: Output Control Register

| Byte : | 1 Pin # | Name     | Control Function                 | Type | 0       | 1      | Default |
|--------|---------|----------|----------------------------------|------|---------|--------|---------|
| Bit 7  | 42/41   | DIF_7_En | Output Control overrides OE# pin | RW   |         |        | 1       |
| Bit 6  | 38/37   | DIF_6_En | Output Control overrides OE# pin | RW   |         | Enable | 1       |
| Bit 5  | 34/35   | DIF_5_En | Output Control overrides OE# pin | RW   |         |        | 1       |
| Bit 4  | 30/29   | DIF_4_En | Output Control overrides OE# pin | RW   | Low/Low |        | 1       |
| Bit 3  | 25/26   | DIF_3_En | Output Control                   | RW   | LOW/LOW |        | 1       |
| Bit 2  | 23/24   | DIF_2_En | Output Control                   | RW   |         |        | 1       |
| Bit 1  | 18/19   | DIF_1_En | Output Control                   | RW   |         |        | 1       |
| Bit 0  | 16/17   | DIF_0_En | Output Control                   | RW   |         |        | 1       |

SMB usTable: Output Control Register

| Byte  | 2 Pin # | Name      | Control Function | Type | 0       | 1      | Default |  |  |  |
|-------|---------|-----------|------------------|------|---------|--------|---------|--|--|--|
| Bit 7 |         |           | Reserved         |      |         |        |         |  |  |  |
| Bit 6 |         |           | Reserved         |      |         |        |         |  |  |  |
| Bit 5 |         |           | Reserved         |      |         |        |         |  |  |  |
| Bit 4 |         |           | Reserved         |      |         |        |         |  |  |  |
| Bit 3 | 55/54   | DIF_11_En | Output Control   | RW   |         |        | 1       |  |  |  |
| Bit 2 | 53/52   | DIF_10_En | Output Control   | RW   | Low/Low | Enable | 1       |  |  |  |
| Bit 1 | 48/47   | DIF_9_En  | Output Control   | RW   | LOW/LOW | Enable | 1       |  |  |  |
| Bit 0 | 46/45   | DIF_8_En  | Output Control   | RW   | 1       |        | 1       |  |  |  |

SMBusTable: Reserved Register

| Byte  | e 3 | Pin # | Name     | Control Function | Type | 0 | 1 | Default |  |
|-------|-----|-------|----------|------------------|------|---|---|---------|--|
| Bit 7 |     |       |          | Reserved         |      |   |   | 0       |  |
| Bit 6 |     |       |          | Reserved         |      |   |   |         |  |
| Bit 5 |     |       |          | Reserved         |      |   |   |         |  |
| Bit 4 |     |       | Reserved |                  |      |   |   | 0       |  |
| Bit 3 |     |       | Reserved |                  |      |   |   | 0       |  |
| Bit 2 |     |       |          | Reserved         |      |   |   | 0       |  |
| Bit 1 |     |       |          | Reserved         |      |   |   | 0       |  |
| Bit 0 |     |       |          | Reserved         |      |   |   | 0       |  |

SMBusTable: Reserved Register

| Byte 4 | Pin # | Name     | Control Function | Type | 0 | 1 | Default |
|--------|-------|----------|------------------|------|---|---|---------|
| Bit 7  |       |          | Reserved         |      |   |   | 0       |
| Bit 6  |       |          | Reserved         |      |   |   | 0       |
| Bit 5  |       | Reserved |                  |      |   | 0 |         |
| Bit 4  |       | Reserved |                  |      |   |   | 0       |
| Bit 3  |       | Reserved |                  |      |   |   | 0       |
| Bit 2  |       |          | Reserved         |      |   |   | 0       |
| Bit 1  |       |          | Reserved         |      |   |   | 0       |
| Bit 0  |       |          | Reserved         |      |   |   | 0       |

SMBusTable: Vendor & Revision ID Register

| 01111111111 | abioi toliadi | a ricvision ib ricgister |                  |      |              |   |         |
|-------------|---------------|--------------------------|------------------|------|--------------|---|---------|
| Byte 5      | 5 Pin #       | Name                     | Control Function | Type | 0            | 1 | Default |
| Bit 7       |               | RID3                     |                  | R    |              |   |         |
| Bit 6       | -             | RID2                     | REVISION ID      | R    | A rev = 0000 |   | X       |
| Bit 5       | -             | RID1                     | HEVISION ID      | R    |              |   | X       |
| Bit 4       | -             | RID0                     |                  | R    |              | Χ |         |
| Bit 3       | -             | VID3                     |                  | R    | -            | - | 0       |
| Bit 2       | -             | VID2                     | VENDOR ID        | R    | -            | - | 0       |
| Bit 1       | -             | VID1                     | VENDORID         | R    | -            | - | 0       |
| Bit 0       | -             | VID0                     |                  | R    | -            | - | 1       |

#### SMBusTable: DEVICE ID

| Byte 6 | Pin # | Name | Control Function | Туре | 0         | 1          | Default |
|--------|-------|------|------------------|------|-----------|------------|---------|
| Bit 7  | -     | D    | evice ID 7 (MSB) | R    |           | 1          |         |
| Bit 6  | -     |      | Device ID 6      | R    |           |            | 1       |
| Bit 5  | -     |      | Device ID 5      | R    |           |            | 1       |
| Bit 4  | -     |      | Device ID 4      | R    | 1230 is 2 | 30 Decimal | 0       |
| Bit 3  | -     |      | Device ID 3      |      | or E      | 6 Hex      | 0       |
| Bit 2  | -     |      | Device ID 2      | R    |           |            | 1       |
| Bit 1  | -     |      | Device ID 1      | R    |           |            | 1       |
| Bit 0  | -     |      | Device ID 0      | R    |           |            | 0       |

SMBusTable: Byte Count Register

| Byte  | 7 | Pin # | Name     | Control Function                        | Type | 0             | 1                 | Default |
|-------|---|-------|----------|---|------|---------------|-------------------|---------|
| Bit 7 |   |       | Reserved |   |      |               | 0                 |         |
| Bit 6 |   |       | Reserved |   |      |               |                   | 0       |
| Bit 5 |   |       | Reserved |   |      |               |                   | 0       |
| Bit 4 |   | -     | BC4      |   | RW   |               |                   | 0       |
| Bit 3 |   | -     | BC3      | Writing to this register configures how | RW   | Default value | 1                 |         |
| Bit 2 |   | -     | BC2      | many bytes will be read back.           |      |               | vill be read back | 0       |
| Bit 1 |   |       | BC1      | many bytes will be read back.           | RW   | by d          | efault.           | 0       |
| Bit 0 |   | -     | BC0      |   | RW   | ĺ             |                   | 0       |

SMBusTable: Reserved Register

| Byte 8 | Pin #          | Name     | Control Function | Type | 0 | 1 | Default |
|--------|----------------|----------|------------------|------|---|---|---------|
| Bit 7  |                |          | Reserved         |      |   |   | 0       |
| Bit 6  |                |          | Reserved         |      |   |   | 0       |
| Bit 5  | Bit 5 Reserved |          |                  |      | 0 |   |         |
| Bit 4  |                | Reserved |                  |      |   | 0 |         |
| Bit 3  |                |          | Reserved         |      |   |   | 0       |
| Bit 2  |                |          | Reserved         |      |   |   | 0       |
| Bit 1  |                |          | Reserved         |      |   |   | 0       |
| Bit 0  |                |          | Reserved         |      |   |   | 0       |

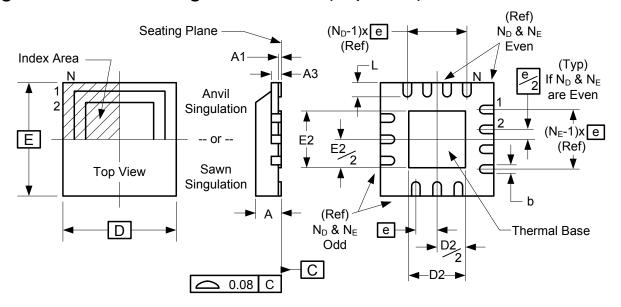
# **Marking Diagram**



#### Notes:

- 1. 'LOT" is the lot number.
- 2. YYWW is the last two digits of the year and week that the part was assembled.
- 3. "L" denotes RoHS compliant package.
- 4. 'COO" denotes country of origin.

## Package Outline and Package Dimensions (56-pin MLF)



|                | Millim  | neters  |
|----------------|---------|---------|
| Symbol         | Min     | Max     |
| Α              | 0.8     | 1.0     |
| A1             | 0       | 0.05    |
| A3             | 0.25 Re | ference |
| b              | 0.18    | 0.3     |
| е              | 0.50 E  | BASIC   |
| D x E BASIC    | 8.00 >  | ₹8.00   |
| D2 MIN./MAX.   | 4.35    | 4.65    |
| E2 MIN./MAX.   | 5.05    | 5.35    |
| L MIN./MAX.    | 0.30    | 0.50    |
| N              | 5       | 6       |
| N <sub>D</sub> | 1       | 4       |
| N <sub>E</sub> | 1       | 4       |

## **Ordering Information**

| Part / Order Number | Marking     | <b>Shipping Packaging</b> | Package    | Temperature |
|---------------------|-------------|---------------------------|------------|-------------|
| 9ZXL1230AKLF        | see page 15 | Trays                     | 56-pin MLF | 0 to +70° C |
| 9ZXL1230AKLFT       |             | Tape and Reel             | 56-pin MLF | 0 to +70° C |

<sup>&</sup>quot;LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

While the information presented herein has been checked for both accuracy and reliability, Integrated Device Technology (IDT) assumes no responsibility for either its use or for the infringement of any patents or other rights of third parties, which would result from its use. No other circuits, patents, or licenses are implied. This product is intended for use in normal commercial applications. Any other applications such as those requiring extended temperature range, high reliability, or other extraordinary environmental requirements are not recommended without additional processing by IDT. IDT reserves the right to change any circuitry or specifications without notice. IDT does not authorize or warrant any IDT product for use in life support devices or critical medical instruments.

<sup>&</sup>quot;A" is the device revision designator (will not correlate with the datasheet revision).

## **Revision History**

| Rev. | Issuer | Issue Date | Description   | Page #                    |
|------|--------|------------|---|---------------------------|
| А    | RDW    | 12/8/2011  | <ol> <li>Changed Output Features description</li> <li>Corrected Title of SMBus Addressing Table</li> <li>Updated tDSPO_BYP to +/-250ps and all Electrical tables with typical values. IDD specs revised downward.</li> <li>Updated Differential Test Loads Figure to indicate impedance and trace length.</li> <li>Removed SMBus Address info on page 12, SMBus address is selectable as indicated on page 3.</li> <li>Mark spec added.</li> <li>Move to final</li> </ol> | 1,3,6-<br>10,11,<br>12,15 |
| В    | RDW    | 4/11/2012  | 1. Updated VDD and VDDIO pin numbers in the Power Connections Table, pinout is correct.   | 2                         |
| С    | RDW    | 11/20/2015 | Updated QPI references to QPI/UPI     Updated DIF_IN table to match PCI SIG specification, no silicon change  | 1,6                       |

9ZXL1230

12-OUTPUT LOW POWER DIFFERENTIAL BUFFER FOR PCIE GEN3 AND QPI

**SYNTHESIZERS** 

#### IMPORTANT NOTICE AND DISCLAIMER

RENESAS ELECTRONICS CORPORATION AND ITS SUBSIDIARIES ("RENESAS") PROVIDES TECHNICAL SPECIFICATIONS AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, WITHOUT LIMITATION, ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for developers skilled in the art designing with Renesas products. You are solely responsible for (1) selecting the appropriate products for your application, (2) designing, validating, and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. Renesas grants you permission to use these resources only for development of an application that uses Renesas products. Other reproduction or use of these resources is strictly prohibited. No license is granted to any other Renesas intellectual property or to any third party intellectual property. Renesas disclaims responsibility for, and you will fully indemnify Renesas and its representatives against, any claims, damages, costs, losses, or liabilities arising out of your use of these resources. Renesas' products are provided only subject to Renesas' Terms and Conditions of Sale or other applicable terms agreed to in writing. No use o any Renesas resources expands or otherwise alters any applicable warranties or warranty disclaimers for these products.

(Disclaimer Rev.1.0 Mar 2020)

### **Corporate Headquarters**

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

### **Trademarks**

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

### **Contact Information**

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit:

www.renesas.com/contact/